

UP-GWS01

Supplier: POKI / box size: 159(L)*140(W)*72(H) mm

Package Drop Test Report

Report NO: 17D030002



Summary	<input checked="" type="checkbox"/> Pass <input type="checkbox"/> Fail Note : There is/are ____ defect(s) not list in the report, please check it in the DTS Website. <input type="checkbox"/> Pass with Deviation Comment: _____
---------	---

Issue date

2017-01-13

QE Manager

KJ Wang

Test Engineer

Ben Sun

Test item list

1. Configuration of EUT ----- 2
 2. Package drop test ----- 3

Num	Item	Spec
System:		UP-GWS01
1.	1. Main Board	UP-X5-Z8300-02 A0.3
	2. BIOS Ver.	UPC1BM0S
	3. CPU Type	Intel CPU.SOC.Cherry Trail-T3.x5-Z8350
	4. Chipset	Intel.SOC.Cherry Trail-T3.x5-Z8350
	5. Onboard Memory	SK Hynix.H5TC8G63CMR-PBA, DDR3L-SDRAM, 4GB
	6. Onboard eMMC	eMMC. Kingston.EMMC64G-M525-A51. 64GB
	7. Test Software	Windows 10 / Run PassMark Burn In Test 8.1 Pro
2.	Adapter:	FSP FSP015-DPAN2 / 5V, 3.0A (15W Max)

Testing Result

Num	Test item list	Result	Remark
1	Package drop test	Pass	

Package Drop Test

Test Date: 01-13-2017

Test Product: UP-GWS01

Test Site: AAEON QE Dept.

Test Standard:

Reference ISTA PROJECT 1A

Test Equipment:

Drop Tester

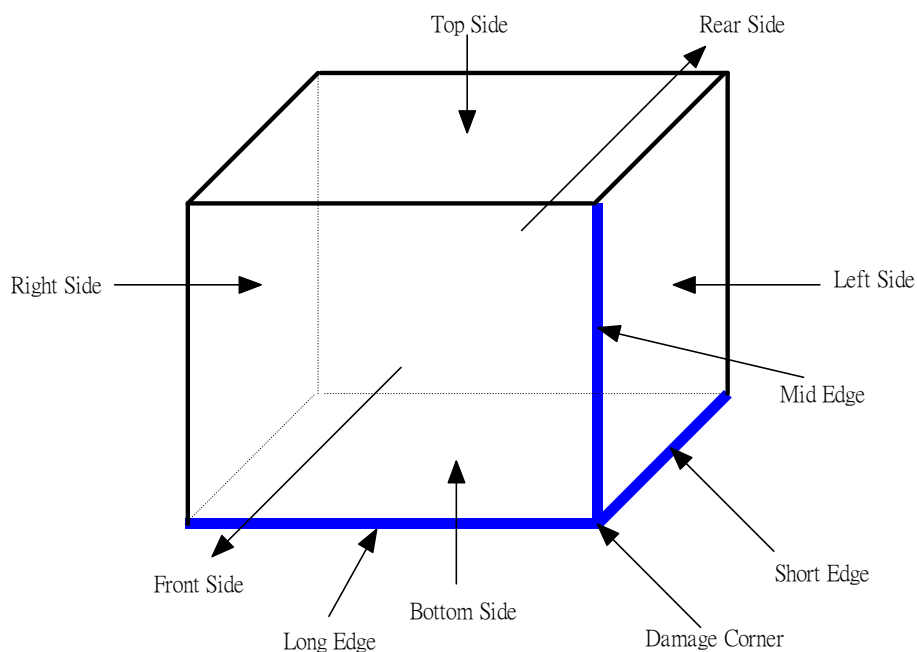
KING DESIGN Co. LTD.

Model: KD-128A

Serial Number: UU110099190

Test Condition:

1. Test Phase: One corner. Three edges. Six face
2. Test Cycle: 1 Cycle
3. Test High: 76cm
4. Test Weight: 0.44Kg
5. Sample Package: 1unit in double-package.
6. Test Drawing:



Test Result:

No issues were found after the packing drop test.